Section I (Amendments to Claims)

Please amend claims 38, 56 and 60, as set out in the following listing of claims 1-69.

1-37. (Cancelled)

38. (Currently Amended) A method of fabricating a ferroelectric PZT film on a substrate, comprising selecting MOCVD conditions for producing a ferroelectric PZT material, and forming the film by liquid delivery MOCVD on the substrate under said MOCVD conditions for producing said ferroelectric PZT material, wherein said selecting MOCVD conditions comprises:

establishing a correlative empirical matrix of plots of each of ferroelectric polarization, leakage current density, and atomic percent lead in PZT films, as a function of each of temperature, pressure and liquid precursor solution A/B ratio, wherein A/B ratio is the ratio of Pb to (Zr + Ti); identifying from said plots an inflection point of each plot, wherein as defining a region of operation with respect to independent process variables of temperature, pressure and liquid precursor solution A/B ratio corresponds to the inflection point or a vicinity thereof; and conducting the liquid delivery MOCVD at temperature, pressure and liquid precursor solution A/B ratio values selected from said region of operation.

- 39. (Original) The method of claim 38, wherein the MOCVD conditions include use of a lead source reagent selected from the group consisting of Pb(thd)₂ and Pb(thd)₂pmdeta.
- 40. (Original) The method of claim 38, wherein the MOCVD conditions include use of a zirconium source reagent selected from the group consisting of Zr(thd)₄ and Zr(O-i-Pr)₂(thd)₂.
- 41. (Original) The method of claim 38, wherein the MOCVD conditions include use of Ti(O-i-

Pr)2(thd)2 as a titanium source reagent.

- 42. (Original) The method of claim 38, wherein the MOCVD conditions include use of Pb(thd)₂, Ti(O-i-Pr)₂(thd)₂ and Zr(thd)₄ as respective lead, titanium and zirconium source reagents.
- 43. (Original) The method of claim 38, wherein the MOCVD conditions include use of Pb(thd)₂pmdeta, Ti(O-i-Pr)₂(thd)₂ and Zr(thd)₄ as respective lead, titanium and zirconium source reagents.
- 44. (Original) The method of claim 38, wherein the MOCVD conditions include use of Pb(thd)₂pmdeta, Ti(O-i-Pr)₂(thd)₂ and Zr(O-i-Pr)₂(thd)₂ as respective lead, titanium and zirconium source reagents.
- 45. (Original) The method of claim 38, wherein the source reagents are provided for liquid delivery MOCVD in a solvent medium comprising one or more solvent species selected from the group consisting of: tetrahydrofuran, glyme solvents, alcohols, hydrocarbon solvents, hydrocaryl solvents, amines, polyamines, and mixtures of two or more of the foregoing.
- 46. (Original) The method of claim 38, wherein the source reagents are provided for liquid delivery MOCVD in a solvent medium comprising tetrahydrofuran: isopropanol: tetraglyme in an 8:2:1 volume ratio.
- 47. (Original) The method of claim 38, wherein the source reagents are provided for liquid delivery MOCVD in a solvent medium comprising octane: decane: polyamine in a 5:4:1 volume ratio.
- 48. (Original) The method of claim 38, wherein the source reagents are provided for liquid delivery MOCVD in a solvent medium comprising octane: polyamine in a 9:1 volume ratio.

- 49. (Original) The method of claim 38, wherein the source reagents are provided for liquid delivery MOCVD in a solvent medium comprising tetrahydrofuran.
- 50. (Original) The method of claim 38, wherein the substrate comprises a noble metal.
- 51. (Original) The method of claim 38, wherein the substrate comprises a noble metal selected from the group consisting of iridium, platinum, and combinations thereof.
- 52. (Original) The method of claim 38, wherein the substrate comprises a TiAlN barrier layer overlaid by an iridium layer.
- 53. (Original) The method of claim 38, wherein the liquid delivery MOCVD includes vaporization of a source reagent solution to form precursor vapor therefrom and flowing the precursor vapor to a CVD chamber in a carrier gas.
- 54. (Original) The method of claim 53, wherein the carrier gas is selected from the group consisting of argon, helium and mixtures thereof.
- 55. (Original) The method according to claim 38, further comprising flowing to the CVD chamber an oxidant medium including at least one species selected from the group consisting of O_2 , O_3 , N_2O , and O_2/N_2O .
- 56. (Currently Amended) A method of fabricating a ferroelectric PZT film on a substrate, comprising selecting MOCVD conditions including nucleation conditions producing a ferroelectric PZT material, and forming the film by liquid delivery MOCVD on the substrate under said MOCVD conditions, wherein

said selecting MOCVD conditions comprises:

establishing a correlative empirical matrix of plots of each of ferroelectric polarization, leakage current density, and atomic percent lead in PZT films, as a function of each of temperature, pressure and liquid precursor solution A/B ratio, wherein A/B ratio is the ratio of Pb to (Zr + Ti);

identifying from said plots an inflection point of each plot, wherein as defining a region of operation with respect to independent process variables of temperature, pressure and liquid precursor solution A/B ratio corresponds to the inflection point or a vicinity thereof; and

conducting the liquid delivery MOCVD at temperature, pressure and liquid precursor solution A/B ratio values selected from said region of operation.

- 57. (Original) A method of fabricating a ferroelectric PZT film on a substrate, comprising forming the film by liquid delivery MOCVD on the substrate under MOCVD conditions including temperature, pressure and liquid precursor solution A/B ratio determined by plateau effect determination from a correlative empirical matrix of plots of each of ferroelectric polarization, leakage current density and atomic percent lead in PZT films, as a function of each of temperature, pressure and liquid precursor solution A/B ratio, wherein A/B ratio is the ratio of Pb to (Zr + Ti).
- 58. (Previously Presented) A method of fabricating a ferroelectric PZT film on a substrate, comprising forming the film by liquid delivery MOCVD on the substrate under MOCVD conditions including temperature, pressure and liquid precursor solution A/B ratio determined by plateau effect determination from a correlative empirical matrix of plots of each of ferroelectric polarization, leakage current density and atomic percent lead in PZT films, as a function of each of temperature, pressure and liquid precursor solution A/B ratio, wherein A/B ratio is the ratio of Pb to (Zr + Ti), and wherein said

ferroelectric PZT film comprises a ferroelectric PZT material having at least one scalable character selected from the group consisting of dimensionally scalable character, pulse length scalable character and E-field scalable character, and wherein said PZT material has at least one property selected from the group consisting of having a thickness from about 20 to about 150 nanometers, having a ferroelectric operating voltage below 2 Volts, having at least one Type 1 properties and having at least one Type 2 properties.

59. (Cancelled)

60. (Currently Amended) A method of fabricating a FeRAM device, comprising selecting MOCVD conditions producing a ferroelectric PZT material, and forming a capacitor on a substrate including a ferroelectric PZT material, wherein the ferroelectric PZT material is deposited by liquid delivery MOCVD under said MOCVD conditions yielding said ferroelectric PZT material, wherein said selecting MOCVD conditions comprises:

establishing a correlative empirical matrix of plots of each of ferroelectric polarization, leakage current density, and atomic percent lead in PZT films, as a function of each of temperature, pressure and liquid precursor solution A/B ratio, wherein A/B ratio is the ratio of Pb to (Zr + Ti);

identifying from said plots an inflection point of each plot, wherein as defining a region of operation with respect to independent process variables of temperature, pressure and liquid precursor solution A/B ratio corresponds to the inflection point or a vicinity thereof; and

conducting the liquid delivery MOCVD at temperature, pressure and liquid precursor solution A/B ratio values selected from said region of operation.

- 61. (Cancelled)
- 62. (Previously Presented) The method of claim 60, wherein the PZT film defines a capacitor area of from about $10^4 \, \mu m^2$ to about $10^{-2} \, \mu m^2$.
- 63. (Cancelled)
- 64. (Cancelled)
- 65. (Previously Presented) The method of claim 38, wherein said MOCVD conditions comprise temperature in a range from about 400°C to about 1200°C, pressure in a range from about 0.1 to about 760 torr, and liquid precursor solution A/B ratio in a range of from about 0.52 to about 1.52.
- 66. (Previously Presented) The method of claim 38, wherein said ferroelectric PZT film has a ferroelectric polarization of greater than 20 μC/cm².
- 67. (Previously Presented) The method of claim 66, wherein said ferroelectric PZT film has a leakage current density of less than 10⁻⁴ A/cm².
- 68. (Previously Presented) The method of claim 67, wherein said ferroelectric PZT film has an atomic percent lead in a range of from about 49.43% to about 55%.
- 69. (Cancelled)